

MOSFET

OptiMOS[™]5 Power-Transistor, 60 V

Features

- Optimized for low voltage motor drives application
 Optimized for battery powered applications
 Enables automated optical solder inspection

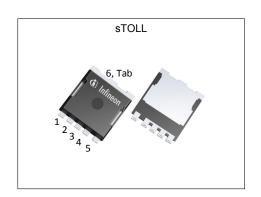
- 100% avalanche tested
- N-channel
- 175°C rated
- Pb-free lead plating : RoHS compliant

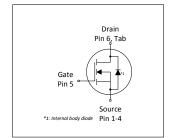
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Roy 1 01101111ai100 1 arainotoro							
Parameter	Value	Unit					
V _{DS}	60	V					
R _{DS(on),max}	1.1	mΩ					
I _D	399	A					
Qoss	123	nC					
Q _G (0V10V)	110	nC					











Type / Ordering Code	Package	Marking	Related Links
IST011N06NM5	sTOLL	011N06N5	-

OptiMOSTM5 Power-Transistor, 60 V IST011N06NM5



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OptiMOS[™]5 Power-Transistor, 60 V IST011N06NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	O b. a.l.	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -		399 282 38	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1596	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	461	mJ	I_D =100 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	313 3.8	W	T _C =25 °C T _A =25 °C, R _{THJA} =40 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Ollit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.3	0.48	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	40	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOSTM5 Power-Transistor, 60 V IST011N06NM5



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.1	-	3.3	V	V _{DS} =V _{GS} , I _D =148 μA
Zero gate voltage drain current	I _{DSS}	-	0.5 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.9 1.27	1.1 1.8	mΩ	V _{GS} =10 V, I _D =100 A V _{GS} =6 V, I _D =50 A
Gate resistance ¹⁾	R _G	-	0.9	-	Ω	-
Transconductance	g fs	165	250	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 100 A$

Table 5 Dynamic characteristics

Davamatar	Symbol	Values			11	Note / Took Condition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	8100	-	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Output capacitance	Coss	-	1900	-	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	71	-	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	t _{d(on)}	-	26	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	35	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	47	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	12	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Cumbal		Values			Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	36	-	nC	V_{DD} =30 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	22	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	$Q_{ m gd}$	-	20	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	33	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Q g	-	110	154	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.4	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	97	-	-	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Qoss	-	123	-	-	V _{DS} =30 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

Final Data Sheet 4 Rev. 2.1, 2022-01-15

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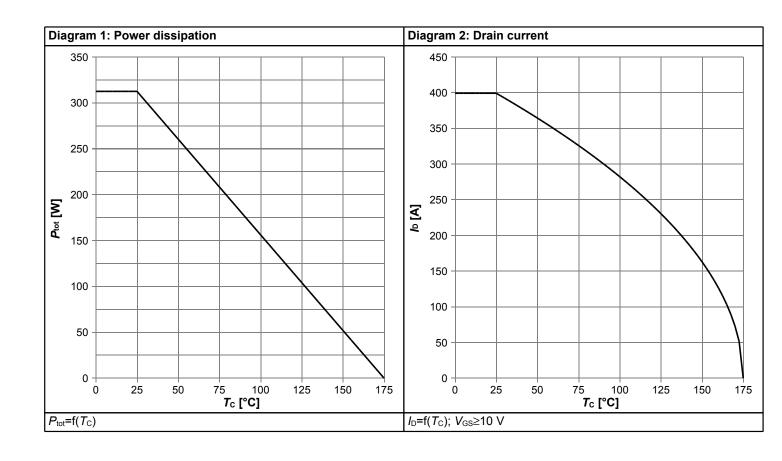


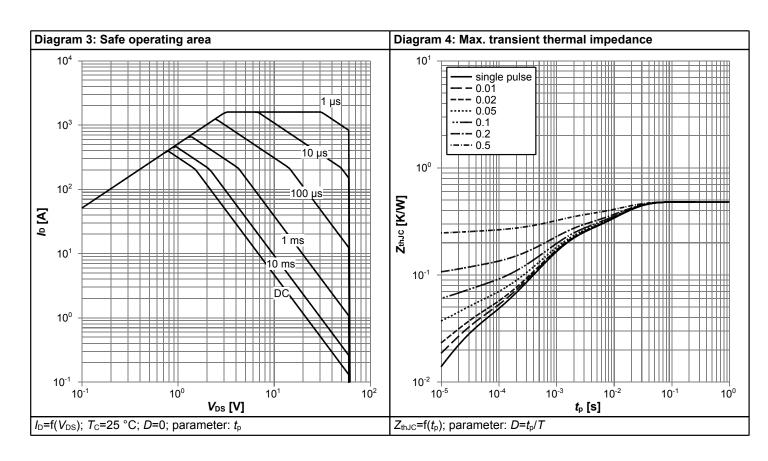
Table 7 Reverse diode

Parameter	Cumbal		Values			Nata / Tank On white a
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	245	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1596	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.9	1.1	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	61	-	ns	V _R =30 V, I _F =100 A, dI _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	93	-	nC	V_R =30 V, I_F =100 A, di_F/dt =100 A/ μ s

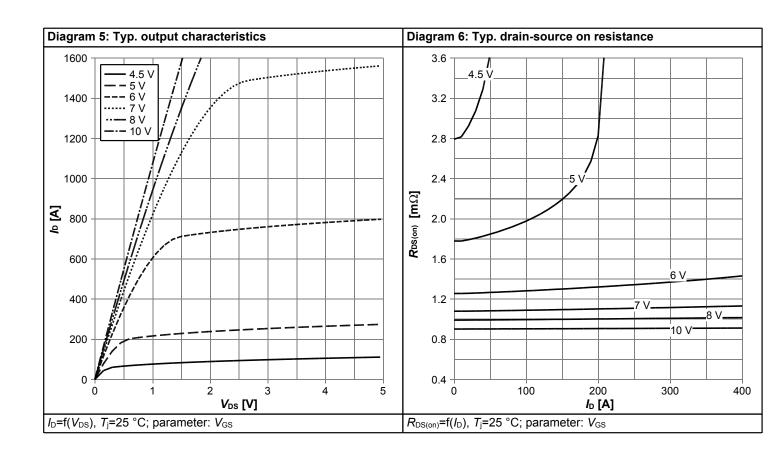


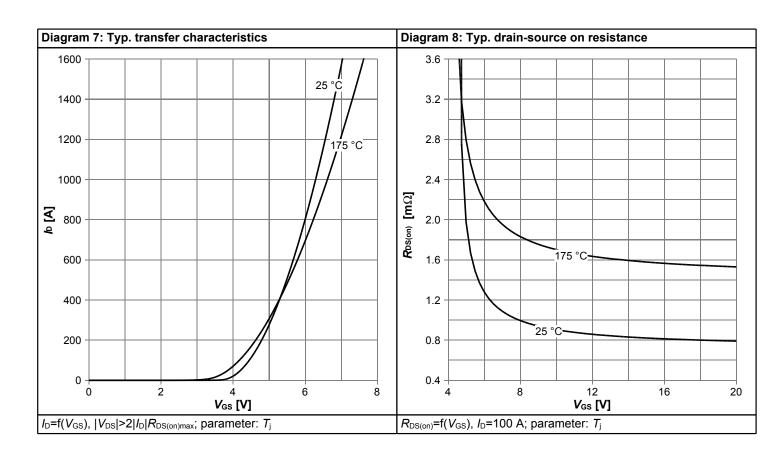
4 Electrical characteristics diagrams



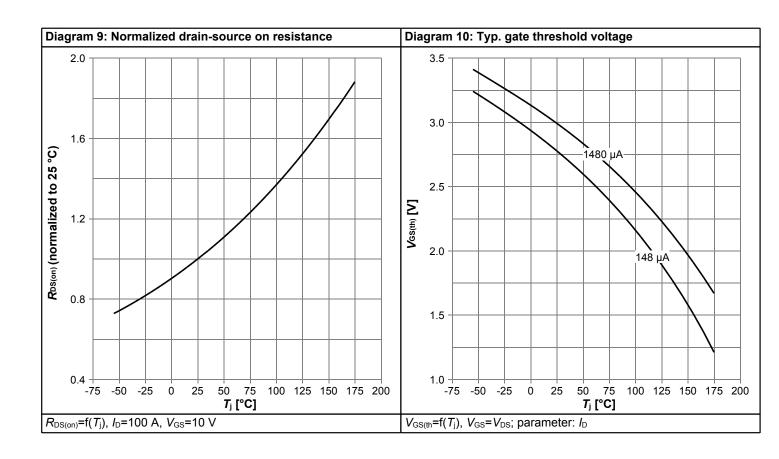


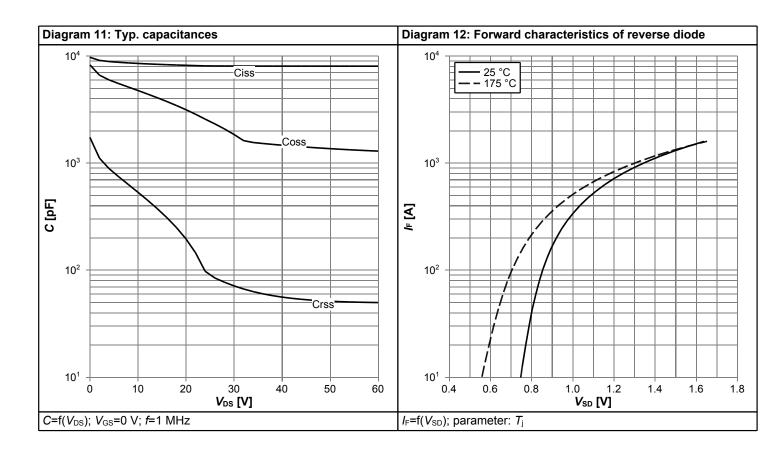




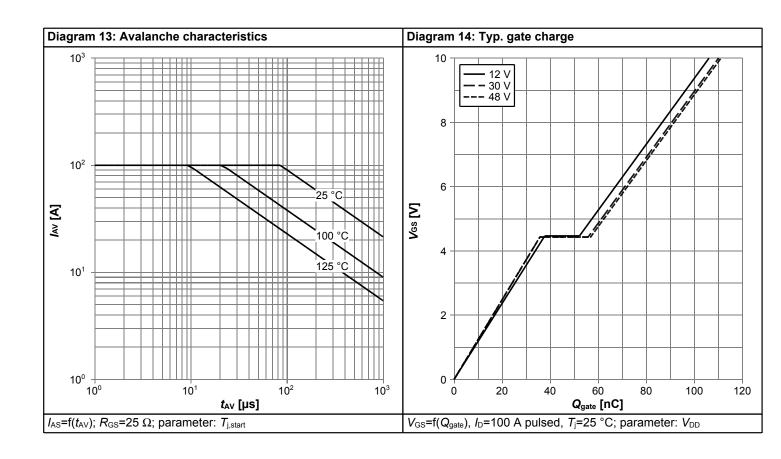


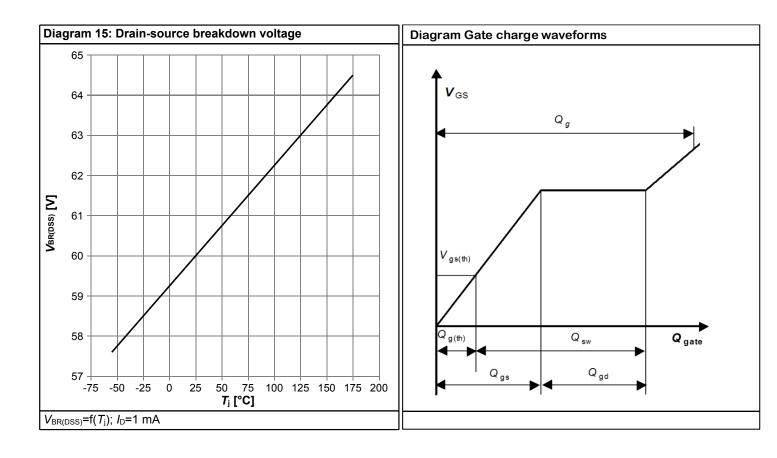














5 Package Outlines

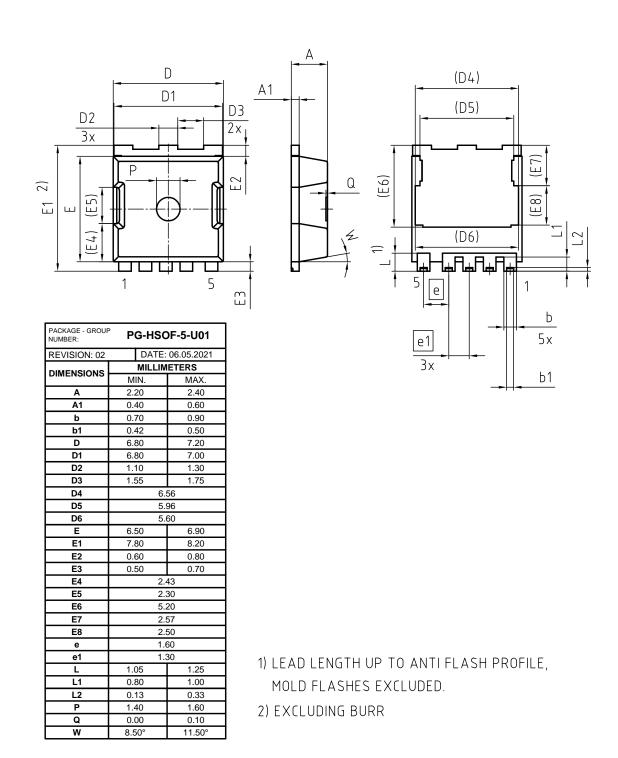


Figure 1 Outline sTOLL, dimensions in mm

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Revision History

IST011N06NM5

Revision: 2022-01-15, Rev. 2.1

Previous Revision

Frevious Revision						
Revision Date Subjects (major changes since last revision)						
2.0	2020-11-23	Release of final version				
2.1	2022-01-15	Update Part Marking				

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